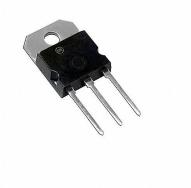


### **TIP36AG Datasheet**

www.digi-electronics.com



https://www.DiGi-Electronics.com

DiGi Electronics Part Number TIP36AG-DG

Manufacturer onsemi

Manufacturer Product Number TIP36AG

Description TRANS PNP 60V 25A TO247-3

Detailed Description Bipolar (BJT) Transistor PNP 60 V 25 A 3MHz 125 W

Through Hole TO-247-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



#### **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
TIP36AG	onsemi
Series:	Product Status:
	Active
Transistor Type:	Current - Collector (Ic) (Max):
PNP	25 A
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, Ic:
60 V	4V @ 5A, 25A
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ Ic, Vce:
1mA	15 @ 15A, 4V
Power - Max:	Frequency - Transition:
125 W	3MHz
Operating Temperature:	Mounting Type:
-65°C ~ 150°C (TJ)	Through Hole
Package / Case:	Supplier Device Package:
TO-247-3	TO-247-3
Base Product Number:	
TIP36	

#### **Environmental & Export classification**

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):	
ROHS3 Compliant	Not Applicable	
REACH Status:	ECCN:	
REACH Unaffected	EAR99	
HTSUS:		



www.onsemi.com

### **Complementary Silicon High-Power Transistors**

## TIP35A, TIP35B, TIP35C (NPN); TIP36A, TIP36B, TIP36C (PNP)

Designed for general-purpose power amplifier and switching applications.

#### **Features**

- 25 A Collector Current
- Low Leakage Current -

 $I_{CEO} = 1.0 \text{ mA} @ 30 \text{ and } 60 \text{ V}$ 

• Excellent DC Gain -

 $h_{FE} = 40 \text{ Typ } @ 15 \text{ A}$ 

• High Current Gain Bandwidth Product -

 $|h_{fe}| = 3.0 \text{ min } @ I_{C}$ = 1.0 A, f = 1.0 MHz

• These are Pb-Free Devices\*

#### **MAXIMUM RATINGS**

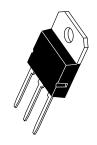
Symbol	Rating	TIP35A TIP35B TIP35C TIP36C		Unit	
V <sub>CEO</sub>	Collector - Emitter Voltage	60	80	100	Vdc
V <sub>CB</sub>	Collector - Base Voltage	60	80	100	Vdc
V <sub>EB</sub>	Emitter - Base Voltage		5.0		Vdc
I <sub>C</sub>	Collector Current  - Continuous  - Peak (Note 1)	25 40		Adc	
Ι <sub>Β</sub>	Base Current - Continuous	5.0		Adc	
P <sub>D</sub>	Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	125		W W/°C	
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-65 to +150		°C	
E <sub>SB</sub>	Unclamped Inductive Load		90		mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

Symbol	Characteristic	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.0	°C/W
R <sub>θJA</sub> Junction-To-Free-Air Thermal Resistance		35.7	°C/W

1. Pulse Test: Pulse Width = 10 ms, Duty Cycle  $\leq$  10%.



SOT-93 (TO-218) CASE 340D STYLE 1



TO-247 CASE 340L STYLE 3

NOTE: Effective June 2012 this device will be available only in the TO-247 package. Reference FPCN# 16827.

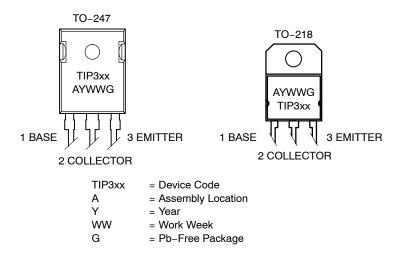
## 25 AMPERE COMPLEMENTARY SILICON POWER TRANSISTORS 60-100 VOLTS, 125 WATTS

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **MARKING DIAGRAMS**



#### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Characteristic		Min	Max	Unit
FF CHARAC	TERISTICS			•	
V <sub>CEO(sus)</sub>	Collector–Emitter Sustaining Voltage (Note 2) $(I_C = 30 \text{ mA}, I_B = 0)$	TIP35A, TIP36A TIP35B, TIP36B TIP35C, TIP36C	60 80 100	- - -	Vdc
I <sub>CEO</sub>	Collector–Emitter Cutoff Current $(V_{CE} = 30 \text{ V}, I_B = 0)$ $(V_{CE} = 60 \text{ V}, I_B = 0)$	TIP35A, TIP36A TIP35B, TIP35C, TIP36B, TIP36C	_ _ _	1.0 1.0	mA
I <sub>CES</sub>	Collector–Emitter Cutoff Current (V <sub>CE</sub> = Rated V <sub>CEO</sub> , V <sub>EB</sub> = 0)		-	0.7	mA
I <sub>EBO</sub>	Emitter-Base Cutoff Current (V <sub>EB</sub> = 5.0 V, I <sub>C</sub> = 0)		<u>-</u> -	1.0	mA
N CHARACT	ERISTICS (Note 2)				
h <sub>FE</sub>	DC Current Gain $(I_C = 1.5 \text{ A, V}_{CE} = 4.0 \text{ V})$ $(I_C = 15 \text{ A, V}_{CE} = 4.0 \text{ V})$		25 15	- 75	_
V <sub>CE(sat)</sub>	Collector–Emitter Saturation Voltage ( $I_C = 15 \text{ A}, I_B = 1.5 \text{ A}$ ) ( $I_C = 25 \text{ A}, I_B = 5.0 \text{ A}$ )		- -	1.8 4.0	Vdc
V <sub>BE(on)</sub>	Base-Emitter On Voltage ( $I_C = 15 \text{ A}, V_{CE} = 4.0 \text{ V}$ ) ( $I_C = 25 \text{ A}, V_{CE} = 4.0 \text{ V}$ )		- -	2.0 4.0	Vdc
YNAMIC CHA	ARACTERISTICS			•	•
h <sub>fe</sub>	Small-Signal Current Gain (I <sub>C</sub> = 1.0 A, V <sub>CE</sub> = 10 V, f = 1.0 kHz)		25	-	-
f <sub>T</sub>	Current-Gain — Bandwidth Product (I <sub>C</sub> = 1.0 A, V <sub>CE</sub> = 10 V, f = 1.0 MHz)		3.0	-	MHz

<sup>2.</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

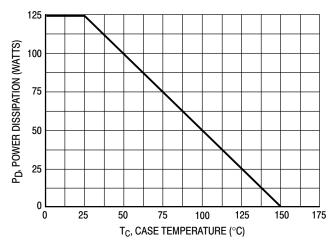
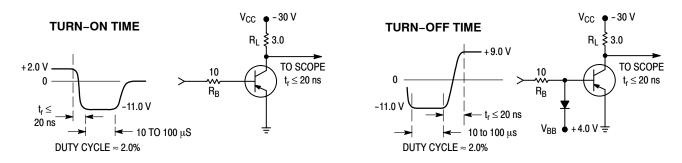


Figure 1. Power Derating



FOR CURVES OF FIGURES 3 & 4,  $R_{B}$  &  $R_{L}$  ARE VARIED. INPUT LEVELS ARE APPROXIMATELY AS SHOWN. FOR NPN, REVERSE ALL POLARITIES.

Figure 2. Switching Time Equivalent Test Circuits

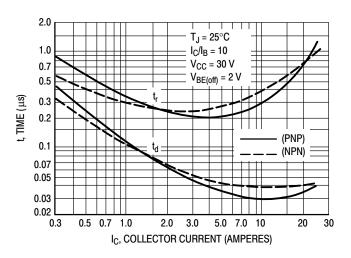


Figure 3. Turn-On Time

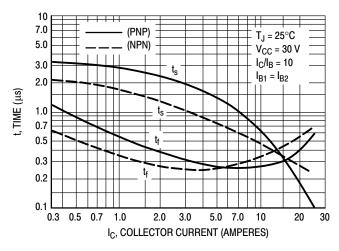


Figure 4. Turn-Off Time

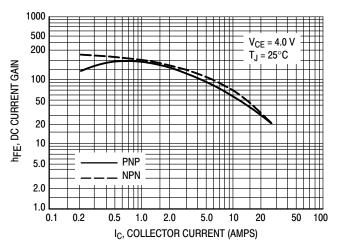


Figure 5. DC Current Gain

#### **FORWARD BIAS**

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 6 is based on  $T_C = 25^{\circ}C$ ;  $T_{J(pk)}$  is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when  $T_C \ge 25^{\circ}C$ . Second breakdown limitations do not derate the same as thermal limitations.

#### **REVERSE BIAS**

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 7 gives RBSOA characteristics.

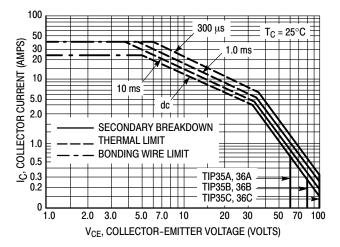


Figure 6. Maximum Rated Forward Bias Safe Operating Area

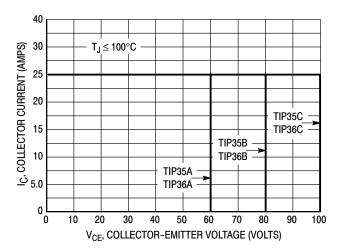
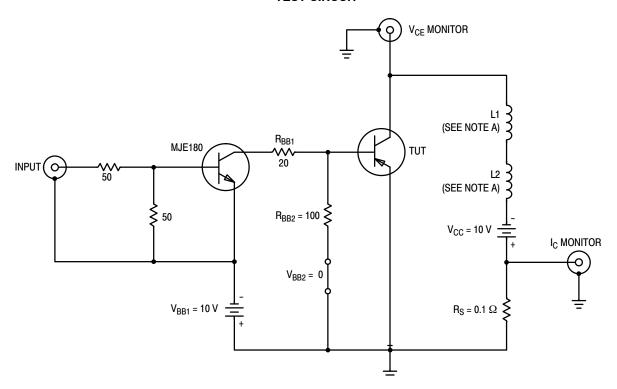
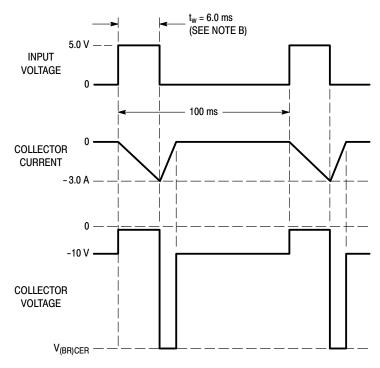


Figure 7. Maximum Rated Forward Bias Safe Operating Area

#### **TEST CIRCUIT**



#### **VOLTAGE AND CURRENT WAVEFORMS**



#### NOTES:

- A. L1 and L2 are 10 mH, 0.11  $\Omega$ , Chicago Standard Transformer Corporation C–2688, or equivalent.
- B. Input pulse width is increased until  $I_{CM} = -3.0 \text{ A}$ .
- C. For NPN, reverse all polarities.

Figure 8. Inductive Load Switching

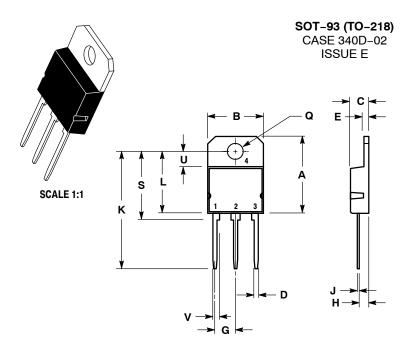
#### **ORDERING INFORMATION**

Device	Package	Shipping
TIP35AG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail
TIP35BG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail
TIP35CG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail
TIP36AG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail
TIP36BG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail
TIP36CG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail
TIP35AG	TO-247 (Pb-Free)	30 Units / Rail
TIP35BG	TO-247 (Pb-Free)	30 Units / Rail
TIP35CG	TO-247 (Pb-Free)	30 Units / Rail
TIP36AG	TO-247 (Pb-Free)	30 Units / Rail
TIP36BG	TO-247 (Pb-Free)	30 Units / Rail
TIP36CG	TO-247 (Pb-Free)	30 Units / Rail



#### **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS



STYLE 1: PIN 1. BASE

2. COLLECTOR 3. EMITTER COLLECTOR

STYLE 2: PIN 1. ANODE CATHODE
 ANODE

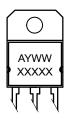
4. CATHODE

**DATE 03 JAN 2002** 

- OTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α		20.35		0.801
В	14.70	15.20	0.579	0.598
С	4.70	4.90	0.185	0.193
D	1.10	1.30	0.043	0.051
E	1.17	1.37	0.046	0.054
G	5.40	5.55	0.213	0.219
Н	2.00	3.00	0.079	0.118
J	0.50	0.78	0.020	0.031
K	31.00	31.00 REF		REF
L		16.20		0.638
Q	4.00	4.10	0.158	0.161
S	17.80	18.20	0.701	0.717
U	4.00 REF		0.157	REF
V	1.75 REF		0.0	)69

#### **GENERIC MARKING DIAGRAM\***



= Assembly Location

= Year WW = Work Week XXXXX = Device Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

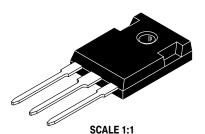
DOCUMENT NUMBER:	98ASB42643B	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED (	
DESCRIPTION:	SOT-93 (TO-218)		PAGE 1 OF 1

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#### **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS



TO-247 CASE 340L ISSUE G

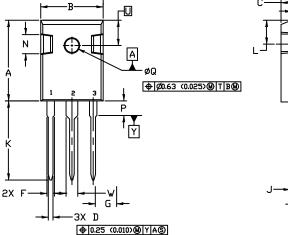
**DATE 06 OCT 2021** 

#### NOTES:

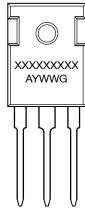
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Ε	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
К	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15 BSC		0.242	BSC
W	2.87	3.12	0.113	0.123

# Α



#### **GENERIC MARKING DIAGRAM\***



STYLE 1: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

PIN 1. CATHODE 2. ANODE

3. GATE 4. ANODE

STYLE 5:

STYLE 2: PIN 1. ANODE 2. CATHODE (S) 3. ANODE 2 4. CATHODES (S)

PIN 1. MAIN TERMINAL 1 2. MAIN TERMINAL 2

3. GATE 4. MAIN TERMINAL 2

STYLE 6:

STYLE 3: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR STYLE 4: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

XXXXX = Specific Device Code Α = Assembly Location

Υ = Year WW = Work Week G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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**DESCRIPTION:** 

TO-247

PAGE 1 OF 1

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